# TOSHIBA

TOSHIBA Photocoupler Photo Relay

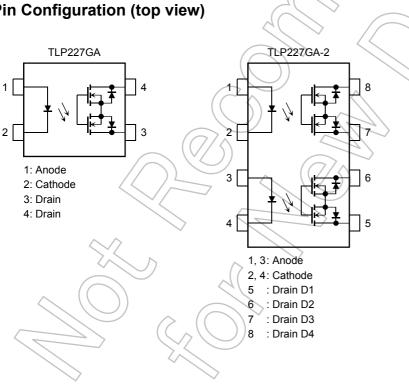
# **TLP227GA, TLP227GA-2**

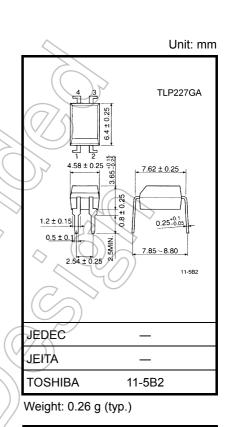
#### Modem **Telecommunications** PBXs

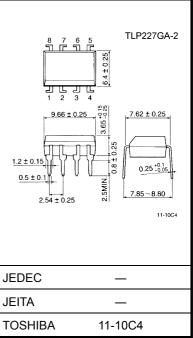
The Toshiba TLP227GA series consist of a gallium arsenide infrared-emitting diode optically coupled to a photo-MOSFET in a 4-pin DIP or a 8-pin DIP package, and has a peak off-State voltage of 400 V.

- Normally off function
- TLP227GA : DIP4 (1 form A) TLP227GA-2
  - : DIP8 (2 form A)
  - Peak off-state voltage :400 V (min)
- Trigger LED current
- On-state current
- : 3 mA (max) : 120 mA (max)  $: 35 \Omega (max)$
- On-state resistance Isolation voltage
- : 2500 Vrms (min)









Weight: 0.54 g (typ.)

Start of commercial production 2000/04

Absolute Maximum Ratings (Ta = 25°C)

		Characteristic		Symbol	Rating	Unit	
	Forward current		١ <sub>F</sub>	50	mA		
Led	Forward current derating (Ta ≥ 25°C)		∆l <sub>F</sub> /°C	-0.5	mA/°C		
	Peak forward current (100 μs pulse, 100 pps)		I <sub>FP</sub>	1	А		
	Reverse volt	age		V <sub>R</sub>	5	V	
	Junction temperature		Tj	125	°C		
	Off-state output terminal voltage		VOFF	400	X	( / )	
	On-state current	TLP227GA			120		
		TLP227GA-2	One channel	I <sub>ON</sub>		Ma	$\sum$
Detector			Both channel				
Dete	On-state	TLP227GA			-1.2	$1( \land \land$	
	current rating (Ta ≥ 25°C)		One channel	∆l <sub>ON</sub> /°C		mA/°C	
			Both channel				$\diamond (0) \overset{\sim}{\bigcirc}$
	Junction temperature			Tj	125	°C	
Storage temperature range		T <sub>stg</sub>	-55 to 125	°C	$\mathcal{C}$		
Operating temperature range			T <sub>opr</sub>	-40 to 85	°C	$(\bigcirc)$	
Lead soldering temperature (10 s)			T <sub>sol</sub>	260	°C	77~	
Isolation voltage (AC, 1 minute, R.H. ≤ 60%) (Note 1)			BVs	2500	Vrms	$\bigcirc$	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: LED pins are shorted together. Detector pins are also shorted together.

#### **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	VDD	_	_	320	V
Forward current	IE	5	7.5	25	mA
On-state current	HON	_	_	100	mA
Operating temperature	Topr	-20		65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

#### Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μA
	Capacitance	CT	V = 0, f = 1 MHz	X	30	_	pF
Detector	Off-state current	I <sub>OFF</sub>	V <sub>OFF</sub> = 400 V			1	μΑ
Dete	Capacitance	C <sub>OFF</sub>	V = 0, f = 1 MHz		<u> </u>		pF

### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>	I <sub>ON</sub> = 120 mA	—	21	ŝ	mA
On-state resistance	R <sub>ON</sub>	I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA	_	18	35	Ω

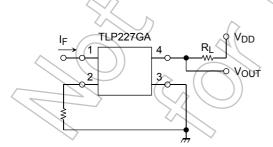
### **Isolation Characteristics (Ta = 25°C)**

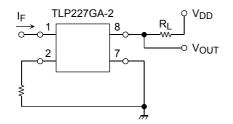
Characteristic	Symbol	Test Condition	Min	√ Тур.	Max	Unit
Capacitance input to output	CS	V <sub>S</sub> =0V, f=1MHz		0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≦ 60%	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
		AC, 1 minute	2500		_	) / mag a
Isolation voltage		AC, 1 second (in oil)	_	5000	_	Vrms
		DC, 1 minute (in oil)	_	5000	_	Vdc

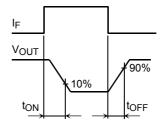
## Switching Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Turn-on time	ton <	R <sub>L</sub> = 200 Ω		_	_	1	<b>m</b> 0
Turn-off time	tOFF	$V_{DD} = 20 V, I_F = 5 mA$	(Note 2)	_		1	ms

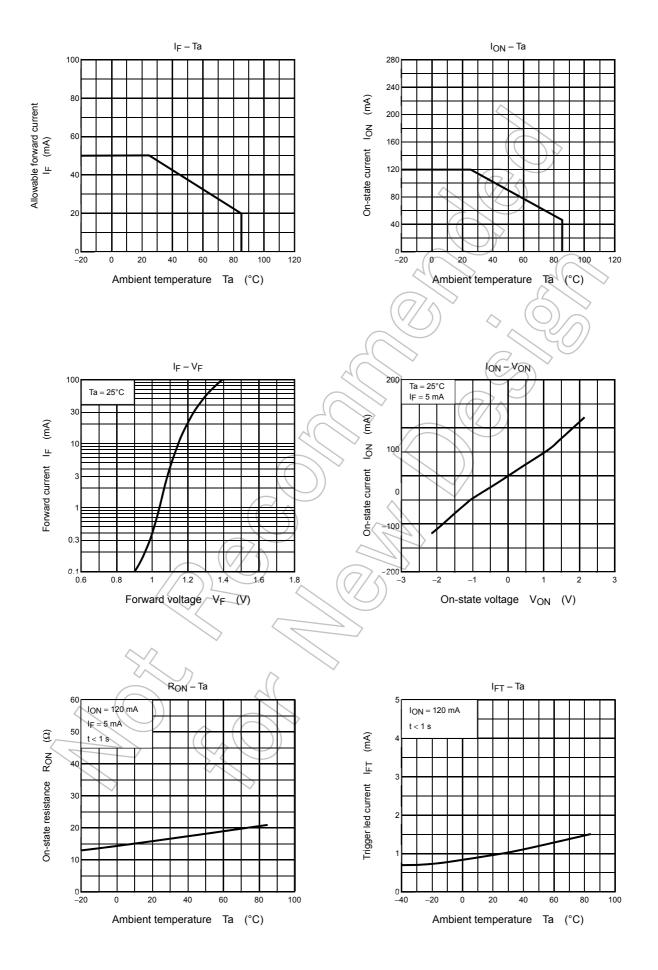
#### Note 2: Switching time test circuit



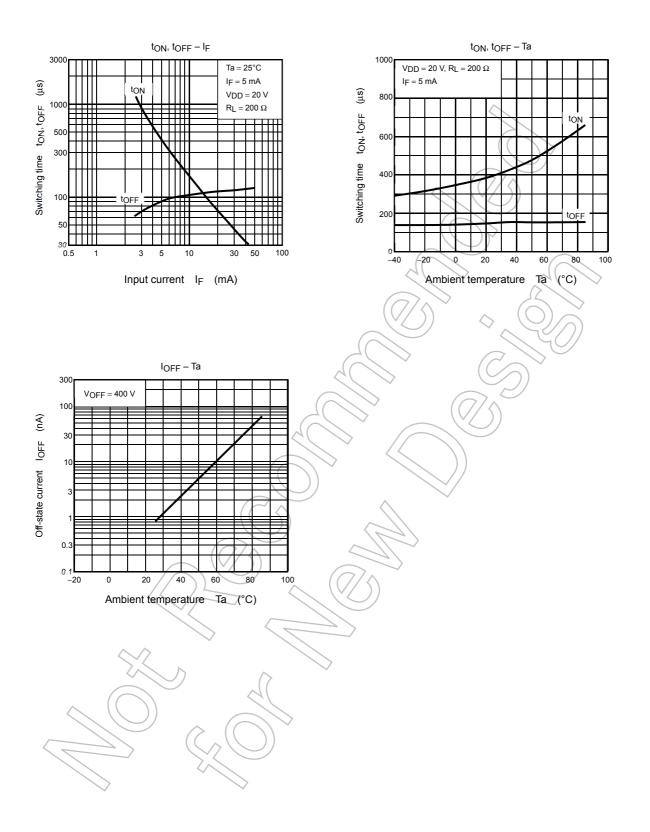




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